

A Systematic 3D Simulation Study Comparing BNL's 3D-Trench Electrode Detectors with Conventional 3D Detectors

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Introduction

Past Silicon Pixel Detectors

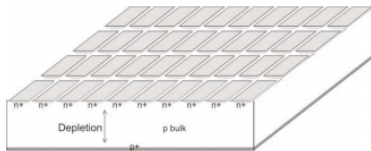


Fig 1a. Typical planar pixel detector.

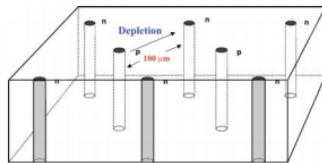


Fig 1b. Standard 3-D detector.

- ▶ Planar pixels (left) have limited depletion zone close to the electrodes at moderately high voltages after high radiation exposure
- ▶ The Conventional 3D detector (right) solved this problem, but introduced a saddle point in the potential and nonhomogeneity in \vec{E} , meaning it introduced a θ dependence.

3D

Advantages of 3D

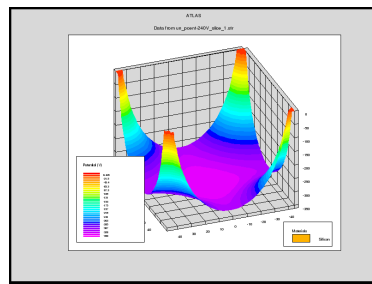
- ▶ Decouples depletion from thickness
- ▶ Reduces depletion voltage by decreasing the electrode spacing

Conventional 3D Limitations

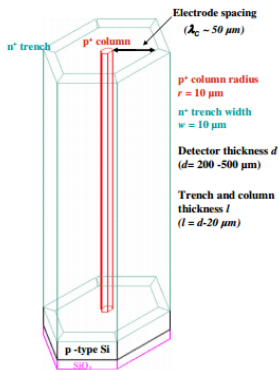
- ▶ High electric field along junction at the column
- ▶ Columns create inhomogeneities in \vec{E}

We want to:

- ▶ Fix the saddle point in the potential.
- ▶ Remove θ dependence
- ▶ Make each cell independent of its neighbors



Our High Energy 3D-Trench Electrode Detector



- ▶ Electrode spacing: $50 \mu\text{m}$
- ▶ Shape: Hexagon

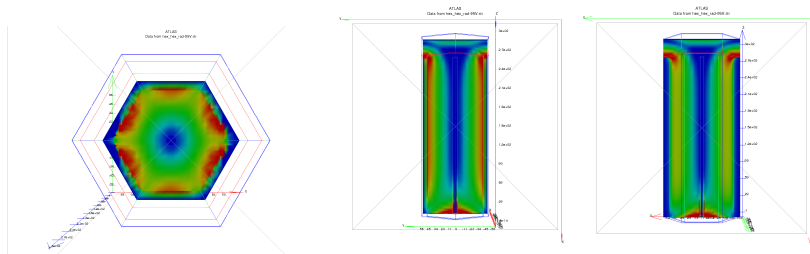
- ▶ Depth: $500 \mu\text{m}$ -
Simulated: $300 \mu\text{m}$
- ▶ Width of doping: $10 \mu\text{m}$
- ▶ Depth of doping:
Simulated - $270/300 \mu\text{m}$
- ▶ When simulated with radiation, treated after $\Phi_{eq} = 10^{16} \text{ 1 MeV } n_{eq}/\text{cm}^2$
- ▶ Doping:
 - ▶ p+ column
 - ▶ n+ trench
 - ▶ p type bulk (simulates after SCSi)

Simulation Specifics

- ▶ Used commercial software from Silvaco (TCAD's programs - Devedit 3d, Device 3d, Atlas, etc) to simulate the detectors' electrical properties.
- ▶ Radiation defects are not built into the program
- ▶ Simulate the detector after high radiation by changing the effective doping concentration of the bulk.
- ▶ This gives us first order effects.

Full Depletion - 95V

Full Depletion Voltage was simulated to be 95 V. Electrode spacing is $50\mu\text{m}$ Treated with $\Phi_{eq} = 10^{16}$ 1 MeV n_{eq}/cm^2

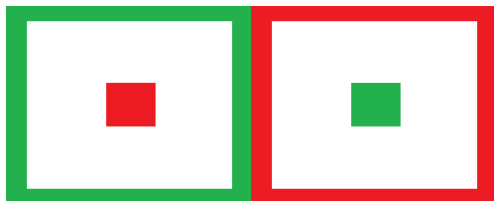


The different types of detectors possible

The different doping does not matter in the conventional detectors, since differences would just correspond to a translation.

- ▶ For our detectors, the difference will cause different \vec{E}
- ▶ We choose:
 - ▶ Doping of the center column
 - ▶ Doping of the cylindrical-shaped trench in each cell
 - ▶ Doping of bulk n (green) and p (red)

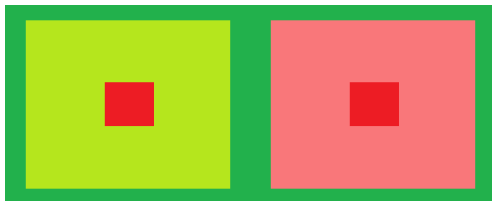
1. Outer trench is n+ and center column is p+
2. Outer trench is p+ and center column is n+



4 Combinations

- ▶ Now for both of the previous two, there are two more versions with the type of doping of the bulk Si
 1. n-type
 2. p-type
- ▶ Under high radiation, the bulk material may undergo space charge sign inversion (SCSI). This “type inversion” turns n-type doping into “p equivalent”
- ▶ **This determines where the junction is, at the trench or at the column**
- ▶ Junction at the column makes high electric field, while having the junction at the trench allows for more uniformity and a lower absolute maximum \vec{E}

1:
pcol
nty
ntre



2:
pcol
pty
ntre

3:
ncol
nty
ptr



4:
ncol
pty
ptre



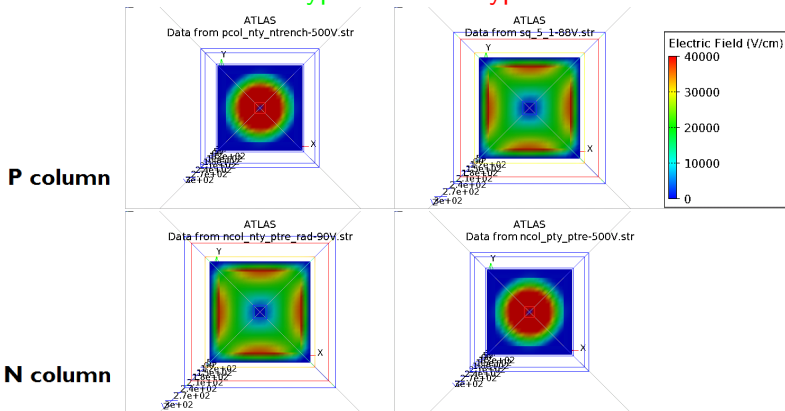
Electric Fields, Fully Radiated

The electrode spacing is $50 \mu m$, and is simulated with

$$\Phi_{eq} = 10^{16} \text{ 1 MeV } n_{eq}/\text{cm}^2$$

N Type

P Type

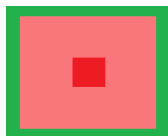


Type Comparison Results

Table: Comparison of Different Doping schemes

column, bulk, trench	V_{dep}	Junction	Dep Direction
n+, n, p+	90 V	trench	inward
n+, p, p+	> 500 V	column	outward
p+, n, n+	> 500 V	column	outward
p+, p, n+	88 V	trench	inward

Therefore, we use p+ column with p-type bulk and n+ trench



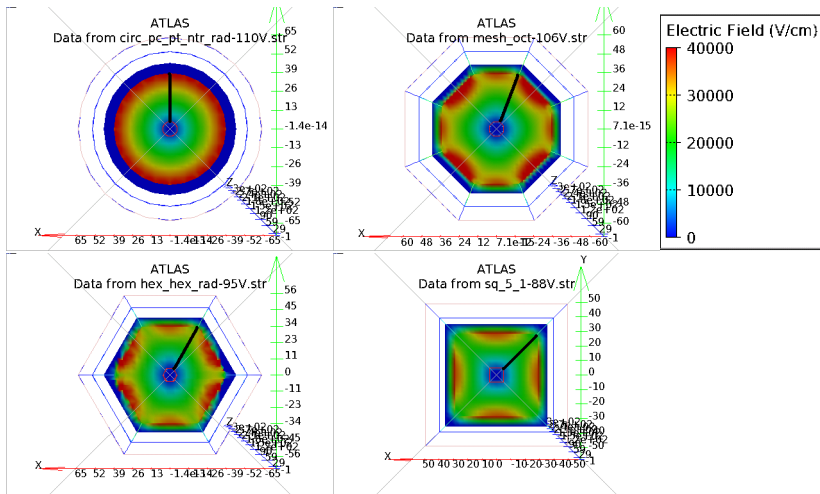
Variable Shapes

- ▶ There are multiple shapes we can simulate the cylindrical trench as:
 - ▶ Circle
 - ▶ Octagon
 - ▶ Hexagon
 - ▶ Square
- ▶ Only the hexagon and square lend themselves to multi-celled arrays because they can be tiled
- ▶ The circle configuration can be useful in scientific studies.
- ▶ We studied the corner effects by comparing these depletion voltages and electric field distributions

- └ Simulations
 - └ Geometry Comparisons

Variable Sides

$\Phi_{eq} = 10^{16}$ 1 MeV n_{eq}/cm^2 , electrode spacing (black line): $50\mu\text{m}$



Variable Sides Results

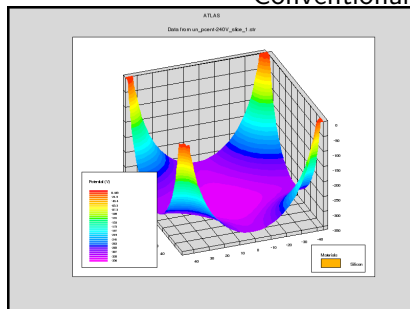
- ▶ The θ dependence decreases as we increase the number of sides
- ▶ The depletion voltage increases with the number of sides because of the increase in volume of each cell

	Square	Hex	Oct	Circle
V_{dep}	88 V	95 V	107 V	110 V

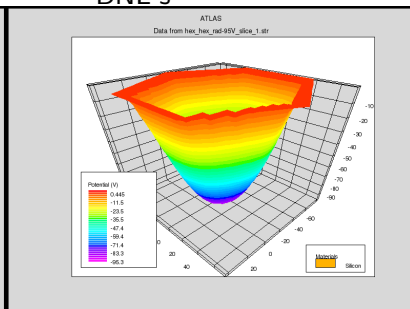
Conventional Vs. BNL's

Potential

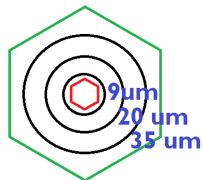
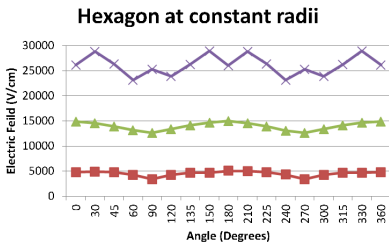
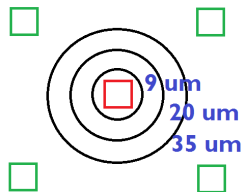
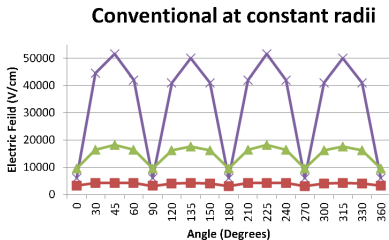
Conventional



BNL's

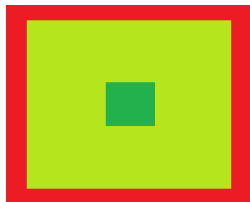


Electric Field's θ Dependence



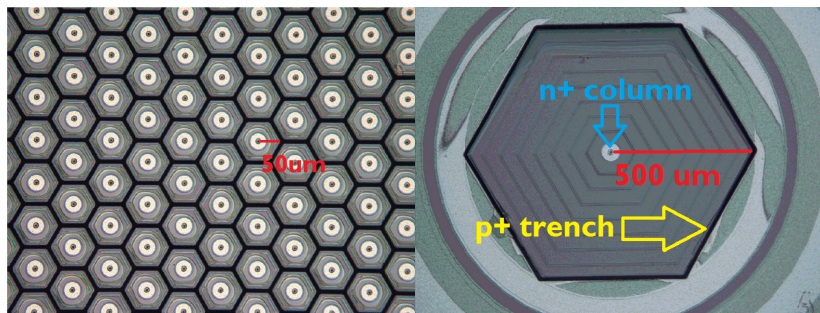
Photon Sciences

- ▶ Also useful for X-ray detection at the National Synchrotron Light Source II at Brookhaven National Laboratory.
- ▶ The natural separation of cells is good for spectrometry
- ▶ Radiation is no longer an issue, simulated at a much lower bulk doping concentration.
- ▶ The cell size is $\approx 500\mu m$ which means it is much larger than the High Energy cells (x10 larger)
- ▶ Chose **n+ column** with **n-type bulk** and **p+ trench**



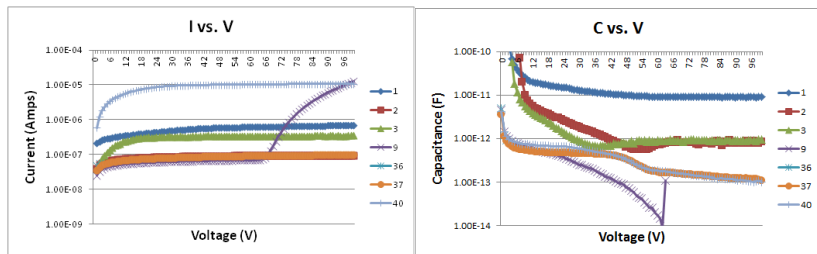
Prototypes

Being manufactured by CNM (National Centre for Micro-electronics)

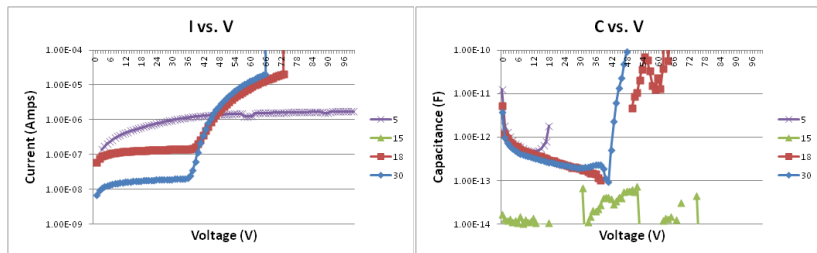


Array of High Energy pixels on left, and a single Photon Science pixel on right.

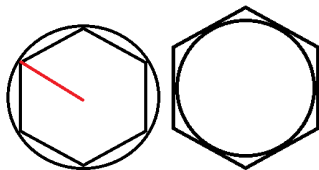
Measurements of Good Prototypes



Measurements of Less than Ideal Prototypes



Conclusions



For V_{dep} , the shapes are all inscribed inside of a circle with electrode spacing of $50\mu m$. For $\langle V_{dep} \rangle$, these shapes are averaged with the shapes which have the same sized circle inscribed inside of it.

Var	Conv	Square	Hex	Oct	Circle
V_{dep}	250 V	88 V	95 V	107 V	110 V
$\langle V_{dep} \rangle$	n/a	120 V	118 V	124 V	110 V
Potential Irregularities	Yes	No	No	No	No

Summary

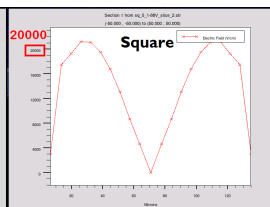
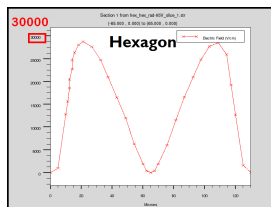
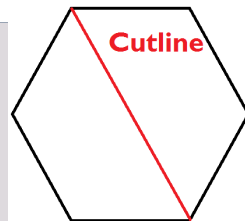
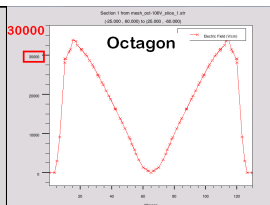
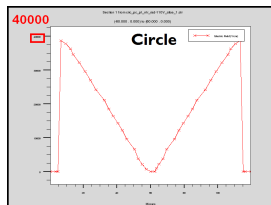
- ▶ Completed a systematic study comparing BNL's 3D-Trench Electrode Detectors with Conventional 3D detectors
- ▶ Simulated BNL's to have a depletion voltage of 95V, about $\frac{2}{5}$ of the conventional detectors.
- ▶ One can also see that the electric field is more uniformly distributed in the hexagonal 3D-Trench Electrode Detectors than in the conventional 3D.
- ▶ Some preliminary measurements from the first prototypes are done.
- ▶ The next step is to measure the charge collection efficiencies
- ▶ CNM has started the next round of prototypes.

Thank you for your attention!

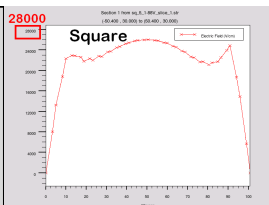
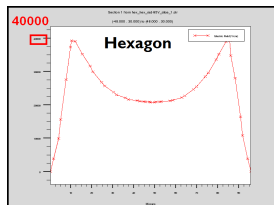
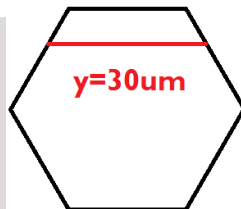
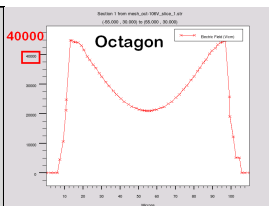
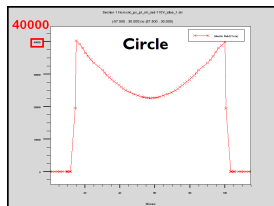
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Silicon detectors with 3-D electrode arrays: Fabrication and initial test results
IEEE Transactions on Nuclear Science, NS46(4) 1999.
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4. Z. Li.
Radiation damage effects in Si materials and detectors and rad-hard Si detectors for SLHC.
Journal of Instrumentation, 4 P03011 2009.

\vec{E} For Different Geometries

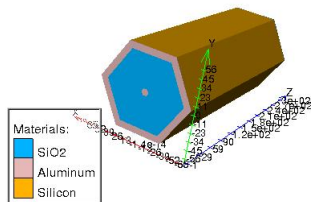


\vec{E} For Different Geometries

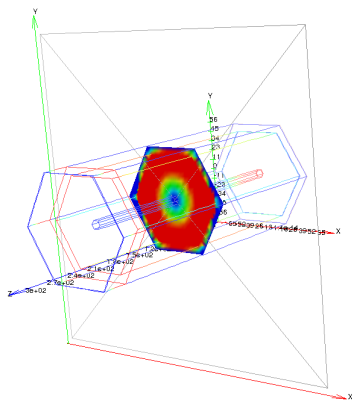


Hexagon Simulation

ATLAS
Data from hex_hex_rad-95V.str

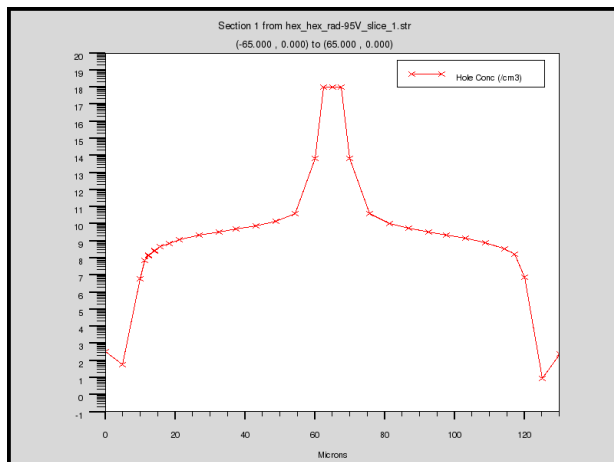


ATLAS
Data from hex_hex_rad-95V.str

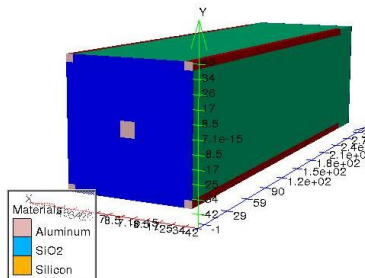


Hole Concentration in Hexagon

$$\Phi_{eq} = 10^{16} \text{ 1 MeV } n_{eq}/\text{cm}^2, V_{dep} = 95V$$



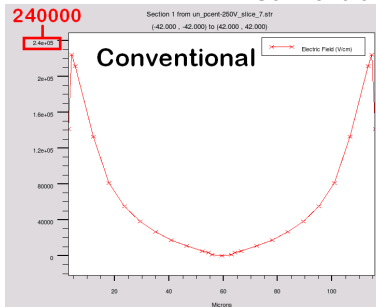
Conventional 3D



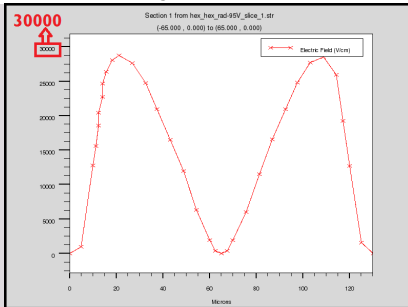
- ▶ Electrode spacing: 50 μm
- ▶ Depth: 300 μm
- ▶ Shape: Conventional
- ▶ Diameter of doping columns: 10 μm
- ▶ When simulated with radiation, treated after $10^{16} n/cm^2$
- ▶ Doping:
 - ▶ p+ center column
 - ▶ n+ corner columns
 - ▶ p type bulk (simulates after SCSI)

\vec{E} Conventional vs. BNL's

Conventional



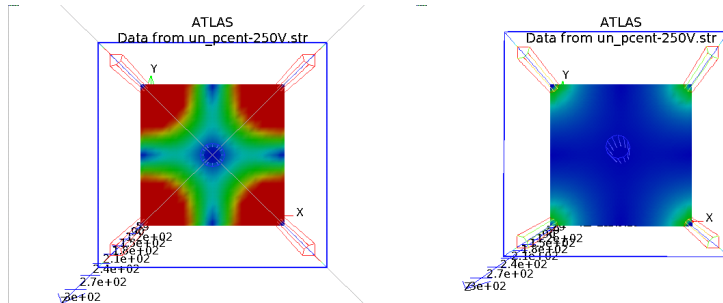
BNL's



Conventional

Full Depletion Voltage was simulated to at 250 V.

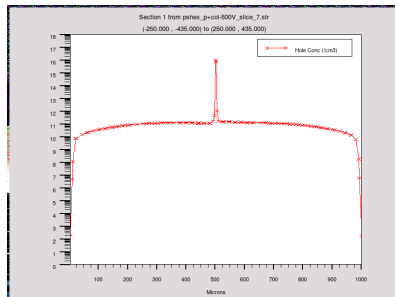
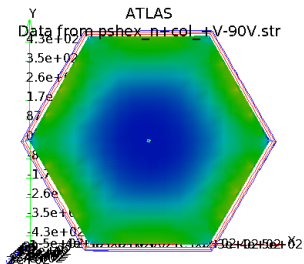
$\Phi_{eq} = 10^{16}$ 1 MeV n_{eq}/cm^2 , electrode spacing: $50\mu\text{m}$



On the left, the maximum (red) is 40,000 V/cm while on the right the maximum is almost 1,300,000.

Type Comparison for Photon Science

At this size, we can only get full depletion before breakdown with $n+$ column and $p+$ trench. Left is $n+$ column fully depleted at 90 V, and right is $p+$ column at 500 V, not close to full depletion.



Electrons Versus Holes

- ▶ There is a difference between collecting and reading out electrons versus holes because of their mobility
- ▶ But because of the high \vec{E} , we don't see the mobility difference over such a small distance
- ▶ This is because we are near the saturation
- ▶ There is only a 20% difference in this case, so it is not significant
- ▶ The trapping is very minimal